

ECE 2126 PHYSICS OF SEMICONDUCTOR DEVICES

FISAC ASSIGNMENT

1. Draw the structure of an n-channel JFET and qualitatively discuss the I–V characteristics, including current directions and voltage polarities.
2. Calculate the internal pinch-off voltage and pinch-off voltage of n-channel JFET. Assume that the p-n junction of a uniformly doped silicon n-channel JFET at $T=300$ K has doping concentrations of $N_a=10^{18} \text{ cm}^{-3}$ and $N_d=10^{16} \text{ cm}^{-3}$. Assume that the metallurgical channel thickness, a , is $0.75 \text{ }\mu\text{m}$.
3. Design the channel doping concentration and metallurgical channel thickness to achieve a given pinch-off voltage. Consider a silicon p-channel p-n JFET at $T=300$ K. Assume that the gate doping concentration is $N_d=10^{18} \text{ cm}^{-3}$. Determine the channel doping concentration and channel thickness so that the pinch-off voltage is 2.25 V .
4. Consider a GaAs n-channel p-n JFET at $T=300$ K with $N_a=10^{18} \text{ cm}^{-3}$, $N_d=3\times 10^{15} \text{ cm}^{-3}$, and $a=0.70 \text{ }\mu\text{m}$. Determine the forward-bias gate voltage required to open a channel region that is $0.10 \text{ }\mu\text{m}$ thick with zero drain voltage.
5. Calculate the maximum current in an n-channel JFET. Consider a silicon n-channel JFET at $T = 300$ K with the following parameters: $N_a = 10^{18} \text{ cm}^{-3}$, $N_d = 10^{16} \text{ cm}^{-3}$, $a = 0.75 \text{ }\mu\text{m}$, $L = 10 \text{ }\mu\text{m}$, $W = 30 \text{ }\mu\text{m}$, and $\mu_n = 1000 \text{ cm}^2/\text{V}\cdot\text{s}$.
6. Describe the basic operation of the MESFET and the mechanism of current saturation in it.
7. Consider an n-channel GaAs MESFET at $T=300$ K with a gold Schottky barrier contact. Assume the barrier height is $\phi_{Bn} = 0.89 \text{ V}$. The n-channel doping is $N_d=2\times 10^{15} \text{ cm}^{-3}$. Design the channel thickness such that $V_T=0.25 \text{ V}$.
8. The Schottky barrier height, ϕ_{Bn} , of a metal–n-GaAs MESFET is 0.90 V . The channel doping is $N_d=1.5\times 10^{16} \text{ cm}^{-3}$, and the channel thickness is $a=0.5 \text{ }\mu\text{m}$. $T=300 \text{ K}$.
 - (a) Calculate the internal pinch-off voltage V_{p0} and the threshold voltage V_T .
 - (b) Determine whether the MESFET is a depletion type or enhancement type.
9. Consider an n-channel GaAs MESFET at $T=300$ K with $\phi_{Bn}=0.85 \text{ V}$ and $a=0.25 \text{ }\mu\text{m}$. Determine the channel doping concentration such that $V_T=0.5 \text{ V}$.
10. Consider an n-channel GaAs MESFET with a gate barrier height of $\phi_{Bn}=0.85 \text{ V}$. The channel doping concentration is $N_d = 5\times 10^{15} \text{ cm}^{-3}$ and the channel thickness is $a = 0.40 \text{ }\mu\text{m}$. Calculate the internal pinch-off voltage and the threshold voltage.